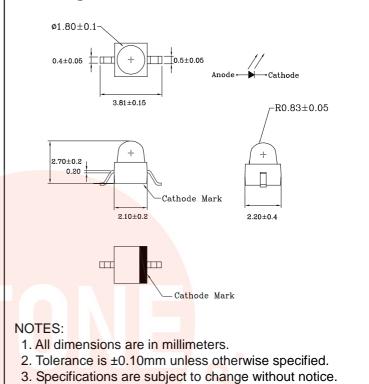


# BL-XUB361-TR7

#### Features:

- 1. Emitted Color: Super Red.
- 2. Lend Appearance: Water Clear.
- 3. Wide range of collector current.
- 4. Low cost plastic package
- 5. This product doesn't contain restriction Substance, comply ROHS standard.

### Package Dimensions:



- Applications:
  - 1. Smoke Detector
  - 2. Automatic Control System

### Absolute Maximum Ratings(Ta=25℃)

Parameter	Symbol	Rating	Unit
Power Dissipation	Pd	50	mW
Forward Current	I <sub>F</sub>	20	mA
Peak Forward Current *1	I <sub>FP</sub>	100	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	Topr	<b>-40°</b> C <b>~85</b> °C	-
Storage Temperature	Tstg	<b>-40°</b> C <b>~85°</b> C	-
Soldering Temperature	Tsol	See Page 5	-

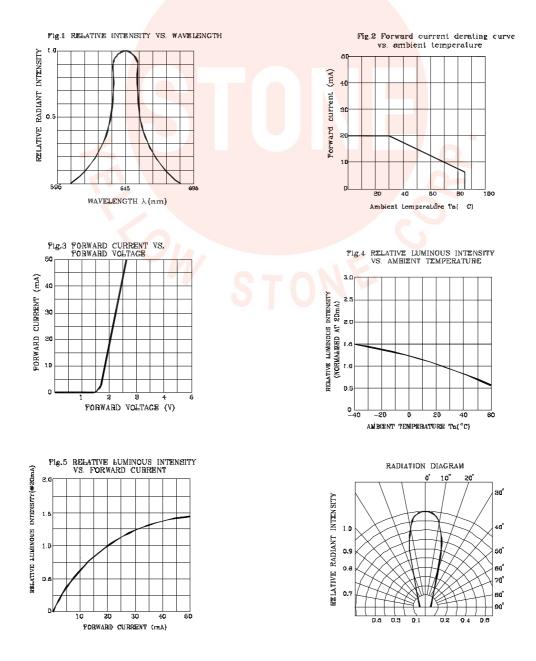
 $\,{\rm *\,1}$  Condition for I\_{\rm FP} is pulse of 1/10 duty and 0.1msec width.



# BL-XUB361-TR7

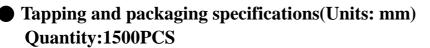
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	I <sub>F</sub> =20mA	-	2.0	2.6	V
Luminous Intensity	lv	I <sub>F</sub> =20mA		317	-	mcd
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	-	-	100	μΑ
Peak Wave Length	λρ	I <sub>F</sub> =20mA	-	645	-	nm
Dominant Wave Length	λd	I <sub>F</sub> =20mA	625		640	nm
Viewing Angle	201/2	IF=20mA	-	35	-	deg

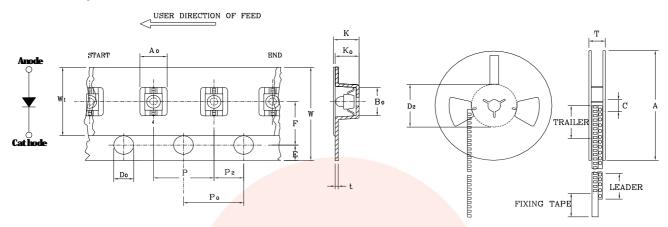
## Typical Electro-Optical Characteristics Curves





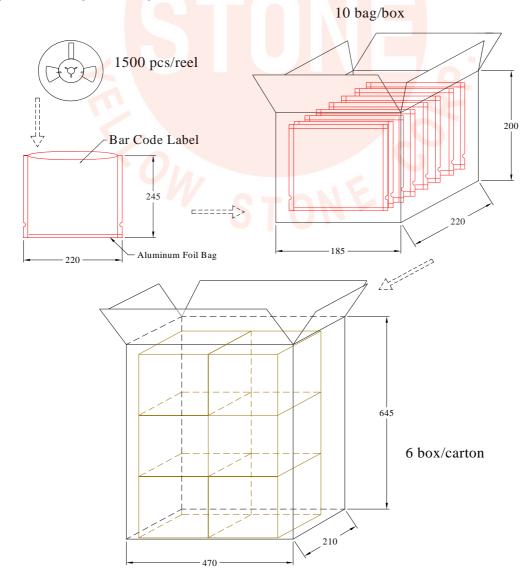
# BL-XUB361-TR7





NOTE: 1500 pcs PER REEL

Package Method:(unit:mm) Vacuum





Reliability Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test		MIL-STD-750D:1026 MIL-STD-883D:1005 JIS-C-7021 :B-1	Ta: Under room temperature Test time:1,000hrs IF=Product Recommended IF	0/32
		MIL-STD-202F:103B JIS-C-7021 :B-11	Ta:85±5℃ RH:90%-95% Test time:240hrs	0/32
	High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B-10	Ta:100±5℃ Test time:1,000hrs	0/32
	Low Temperature Storage	JIS-C-7021 :B-11	Ta: -45±5℃ Test time=1,000hrs	0/32
Environmental Test	Temperature Cycling	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS-C-7021 :A-2	Ta:-35±5℃~25±5℃~85±5℃~25±5℃ 30min 5min 30min 5min Time: 5cycles	0/32
		MIL-STD-202F:107D( 1980) MIL-STD-750D:1051( 95) MIL-STD-883D:1011(1 991)	Ta:-45±5℃ ~+85±5℃ 20min 20 min Time: 10cycles	0/32
	Wetting balance	MIL-STD-883: <mark>2003</mark> MIL-STD-202 <b>F:2</b> 08D MIL-STD-883D:2003	Ta:230±5℃ Time:5±0.5s	0/32
	Solder Resistance	MIL-STD-202F:210A MIL-STD-883D:1011 JIS-C-7021 :A-1	Ta:260±10℃ Time:10±1s	0/32

### • Judgment criteria of failure for the reliability

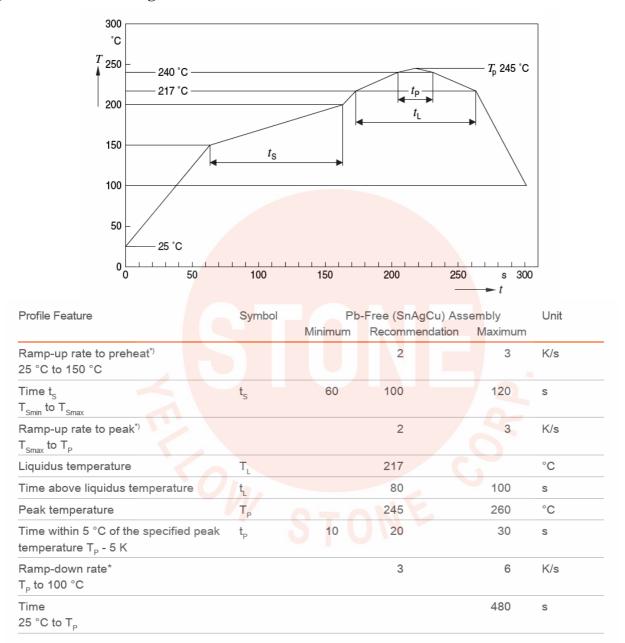
Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	V <sub>F</sub> (V)	I <sub>F</sub> =20mA	Initial Level*1.1
Reverse current	I <sub>R</sub> (uA)	V <sub>R</sub> =5V	Over U*2
Luminous intensity	lv(mcd)	I <sub>F</sub> =20mA	Initial Level*0.7

Note: 1.U means the upper limit of specified characteristics.

2. Measurement shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.



**IR-Reflow Soldering** 



All temperatures refer to the center of the package, measured on the top of the component \* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process.
- 3. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs.

IRON Soldering

### $350^{\circ}$ Within 3 sec.,One time only.



### Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the LEDs within the rated figures. Also, caution should be taken not to overload LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the LEDs.

#### Storage:

In order to avoid the absorption of moisture, it is recommended to solder LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature :  $5^{\circ}$ C  $30^{\circ}$ C ( $41^{\circ}$ F)Humidity : RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be: a. Completed within168 hours.
- b. Stored at less than 30% RH.
- (3) Devices require baking before mounting, if: (2) a or (2) b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at  $60^{\circ}$ C ±  $3^{\circ}$ C.

#### Package and Label of Products:

- (1) Package: Products are packed in one bag of 2000 pcs (one taping reel) and a label is attached on each bag.
- (2) Label:

STONE 早安股份有限公司 YELLOW STONE CORP.	NE
Part No.: BL-Hxxxxx-TRB	— Part No.
Quantity:xxxx ← BIN:x ←	— Quantity — BIN.
Sealing date:xxxxx <	— Sealing Date <u>X XX XX</u>
Manufac	Year Cycle